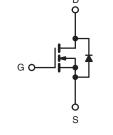




E Series Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} max. at 25 °C (Ω)	V _{GS} = 10 V 0.125			
Q _g max. (nC)	130			
Q _{gs} (nC)	15			
Q _{gd} (nC)	39			
Configuration	Single			





N-Channel MOSFET

FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (C_{iss})
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
 - LED lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
- Battery chargers
- Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free	SiHG30N60E-E3
Lead (Pb)-free and Halogen-free	SiHG30N60E-GE3

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	less otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V _{DS}	600	V
Gate-Source Voltage			V _{GS}	± 30	v
Continuous Drain Current (T 150 °C)	V _{GS} at 10 V	$T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$	1	29	
Continuous Drain Current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 100 °C	I _D	18	А
Pulsed Drain Current ^a			I _{DM}	65	
Linear Derating Factor				2	W/°C
Single Pulse Avalanche Energy ^b			E _{AS}	690	mJ
Maximum Power Dissipation			PD	250	W
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C
Drain-Source Voltage Slope $V_{DS} = 0 V to 80 \% V_{DS}$			dV/dt	70	V/ns
Reverse Diode dV/dt ^d			uv/dt	18	v/ns
Soldering Recommendations (Peak Temperature) ^c	for	10 s		300	°C

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 7 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D, \, dI/dt$ = 100 A/µs, starting T_J = 25 °C.

1 For technical questions, contact: <u>hvm@vishay.com</u>



COMPLIANT

HALOGEN



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	0.5	0/10	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		•				•	•
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 250 μA	-	0.64	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μΑ	2.0	2.8	4.0	V
Onto Onima Lankana		,	V _{GS} = ± 20 V	-	-	± 100	nA
Gate-Source Leakage	I _{GSS}	,	V _{GS} = ± 30 V	-	-	± 1	μA
Zara Cata Valtaga Drain Current	I	V _{DS} =	= 600 V, V _{GS} = 0 V	-	-	1	
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 600 V	∕, V _{GS} = 0 V, T _J = 150 °C	-	-	100	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V I _D = 15 A		-	0.104	0.125	Ω
Forward Transconductance ^a	9 _{fs}	V _D s	_S = 8 V, I _D = 3 A	-	5.4	-	S
Dynamic				•	•	•	•
Input Capacitance	C _{iss}		$V_{GS} = 0 V$,	-	2600	-	
Output Capacitance	C _{oss}		$V_{DS} = 100 V,$	-	138	-	1
Reverse Transfer Capacitance	C _{rss}	$V_{\rm DS} = 100 \text{ V},$ - 138		-	pF		
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$		-			
Effective Output Capacitance, Time Related ^b	C _{o(tr)}	$V_{\rm DS} = 0$	$v to 480 v, v_{GS} = 0 v$	-	346	-	
Total Gate Charge	Qg			-	85	130	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	I _D = 15 A, V _{DS} = 480 V	-	15	-	nC
Gate-Drain Charge	Q _{gd}			-	39	-	
Turn-On Delay Time	t _{d(on)}			-	19	40	
Rise Time	t _r	V _{DD} =	= 380 V, I _D = 15 A,	-	32	65	
Turn-Off Delay Time	t _{d(off)}	V _{GS} =	= 10 V, $R_{g} = 4.7 \Omega$	-	63	95	ns
Fall Time	t _f			-	36	75	
Gate Input Resistance	Rg	f = 1	MHz, open drain	-	0.63	-	Ω
Drain-Source Body Diode Characteristic	s				-		
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the		-	-	29	
Pulsed Diode Forward Current	I _{SM}	integral re p - n junction		-	-	65	A
Diode Forward Voltage	V _{SD}	T _J = 25 °C	C, I _S = 15 A, V _{GS} = 0 V	-	-	1.3	V
Body Diode Reverse Recovery Time	t _{rr}			-	402	605	ns
Body Diode Reverse Recovery Charge	Q _{rr}	T _J = 25 dl/dt =	5 °C, I _F = I _S = 15 A, 100 A/µs ^{, V} _B = 20 V	-	7	15	μC
Reverse Recovery Current	I _{RRM}			-	32	65	Α

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

b. C_{oss(tr)} is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}.



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

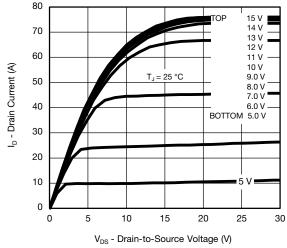
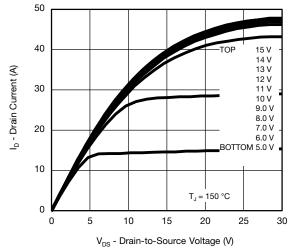
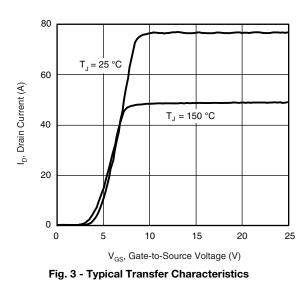


Fig. 1 - Typical Output Characteristics, T_C = 25 °C







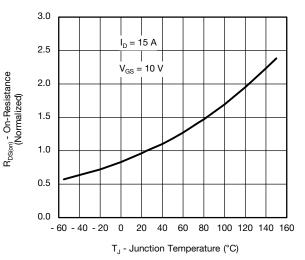


Fig. 4 - Normalized On-Resistance vs. Temperature

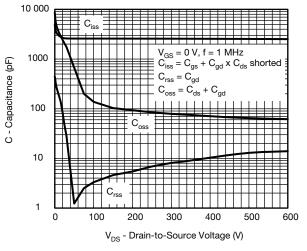
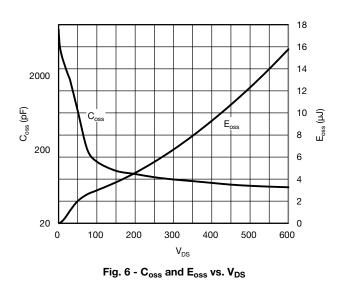


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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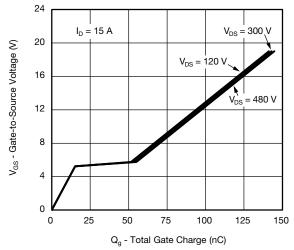


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

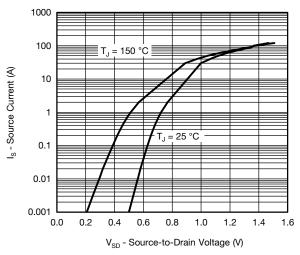


Fig. 8 - Typical Source-Drain Diode Forward Voltage

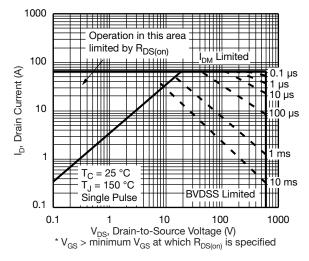


Fig. 9 - Maximum Safe Operating Area

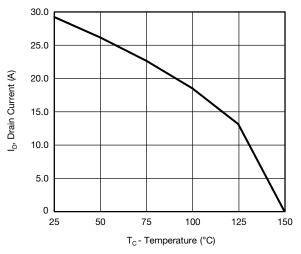


Fig. 10 - Maximum Drain Current vs. Case Temperature

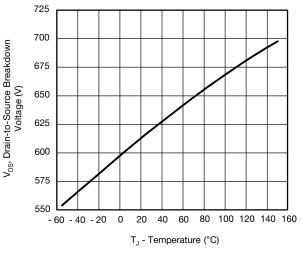
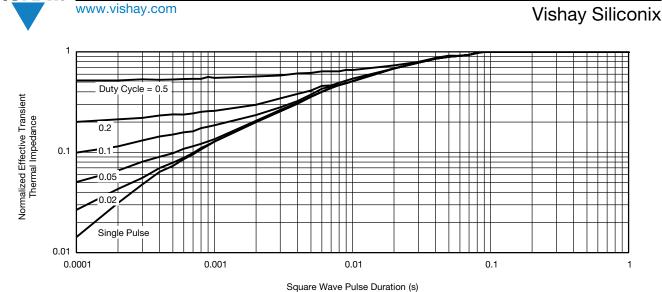


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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4

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Square Wave Pulse Duration (s) Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

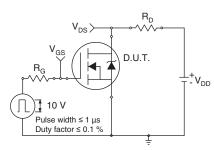


Fig. 13 - Switching Time Test Circuit

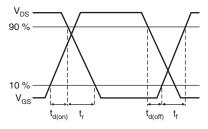


Fig. 14 - Switching Time Waveforms

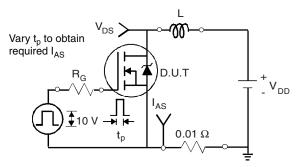


Fig. 15 - Unclamped Inductive Test Circuit

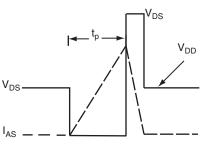


Fig. 16 - Unclamped Inductive Waveforms

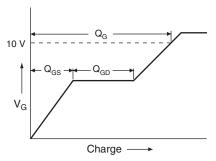


Fig. 17 - Basic Gate Charge Waveform

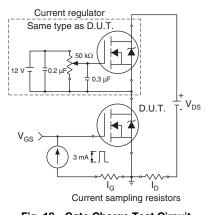


Fig. 18 - Gate Charge Test Circuit

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5

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Peak Diode Recovery dV/dt Test Circuit

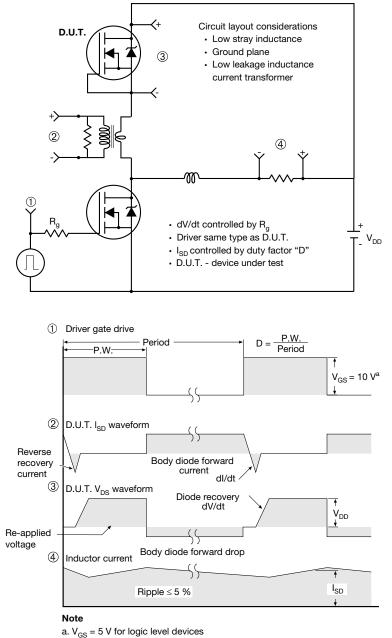


Fig. 19 - For N-Channel

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Vishay Siliconix

TO-247AC (High Voltage)

VERSION 1: FACILITY CODE = 9





Section C--C, D--D, E--E

	MILLIN	IETERS	
DIM.	MIN.	MAX.	NOTES
А	4.83	5.21	
A1	2.29	2.55	
A2	1.50	2.49	
b	1.12	1.33	
b1	1.12	1.28	
b2	1.91	2.39	6
b3	1.91	2.34	
b4	2.87	3.22	6, 8
b5	2.87	3.18	
С	0.55	0.69	6
c1	0.55	0.65	
D	20.40	20.70	4

	MILLIN			
DIM.	MIN.	MAX.	NOTES	
D1	16.25	16.85	5	
D2	0.56	0.76		
E	15.50	15.87	4	
E1	13.46	14.16	5	
E2	4.52	5.49	3	
е	5.44	5.44 BSC		
L	14.90	15.40		
L1	3.96	4.16	6	
ØP	3.56	3.65	7	
Ø P1	7.19	7.19 ref.		
Q	5.31	5.69		
S	5.54	5.74		

Notes

- ⁽¹⁾ Package reference: JEDEC[®] TO247, variation AC
- (2) All dimensions are in mm
- ⁽³⁾ Slot required, notch may be rounded
- ⁽⁴⁾ Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm per side. These dimensions are measured at the outermost extremes of the plastic body
- ⁽⁵⁾ Thermal pad contour optional with dimensions D1 and E1
- (6) Lead finish uncontrolled in L1
- (7) Ø P to have a maximum draft angle of 1.5° to the top of the part with a maximum hole diameter of 3.91 mm
- (8) Dimension b2 and b4 does not include dambar protrusion. Allowable dambar protrusion shall be 0.1 mm total in excess of b2 and b4 dimension at maximum material condition



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VERSION 2: FACILITY CODE = Y



	MILLIMETERS			MILLIMETERS			
DIM.	MIN.	MAX.	NOTES	DIM.	MIN.	MAX.	NOTE
А	4.58	5.31		D2	0.51	1.30	
A1	2.21	2.59		E	15.29	15.87	
A2	1.17	2.49		E1	13.72	-	
b	0.99	1.40		е	5.46	BSC	
b1	0.99	1.35		Øk	0.	254	
b2	1.53	2.39		L	14.20	16.25	
b3	1.65	2.37		L1	3.71	4.29	
b4	2.42	3.43		ØР	3.51	3.66	
b5	2.59	3.38		Ø P1	-	7.39	
С	0.38	0.86		Q	5.31	5.69	
c1	0.38	0.76		R	4.52	5.49	
D	19.71	20.82		S	5.51	BSC	
D1	13.08	-					

Notes

- ⁽¹⁾ Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- ⁽⁴⁾ Thermal pad contour optional with dimensions D1 and E1
- ⁽⁵⁾ Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- ⁽⁷⁾ Outline conforms to JEDEC outline TO-247 with exception of dimension c



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